

## FEATURES:

- Optimized for 2.5V LVTTTL
- Guaranteed Low Skew < 25ps (max)
- Very low duty cycle distortion < 300 (max)
- High speed propagation delay < 1.8ns. (max)
- Up to 200MHz operation
- Very low CMOS power levels
- Hot insertable and over-voltage tolerant inputs
- 1:5 fanout buffer
- 2.5V V<sub>DD</sub>
- Available in TSSOP package
- *For New Designs use functional replacement 8L30110*

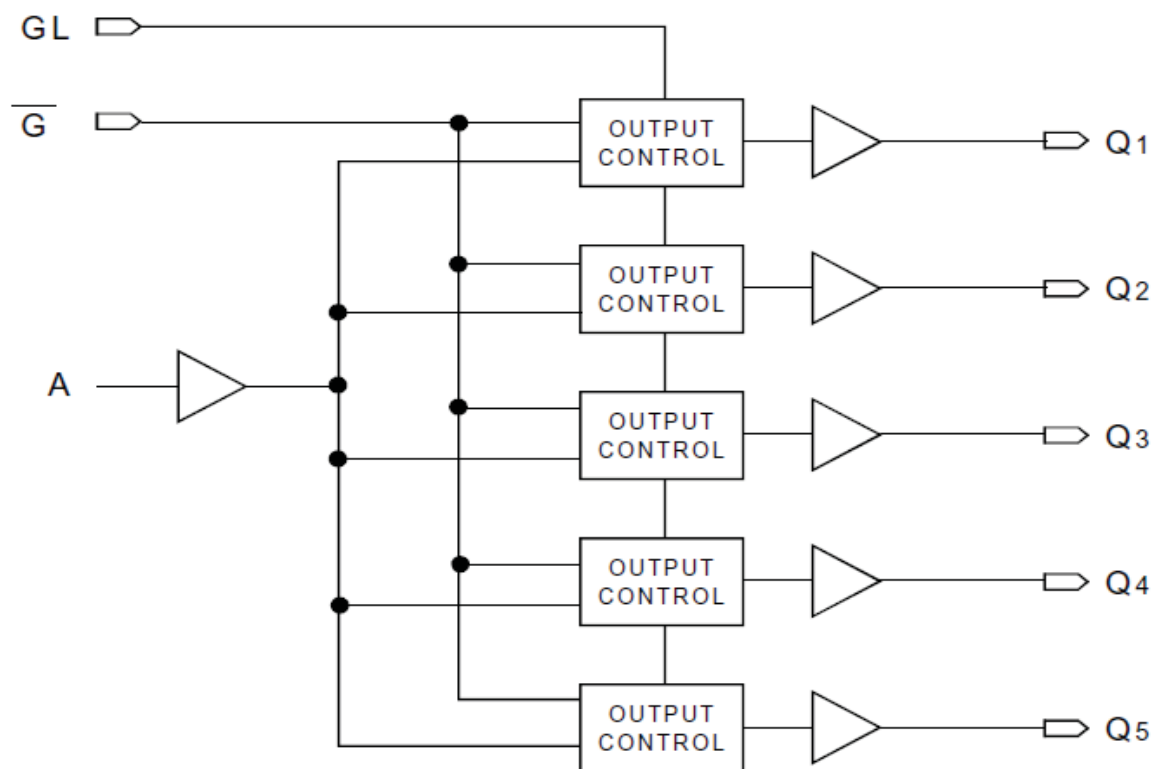
APPLICATIONS:

- Clock and signal distribution

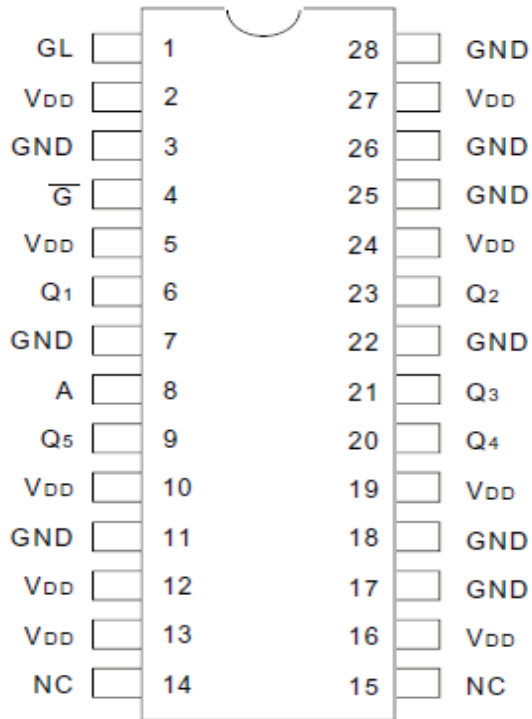
DESCRIPTION:

The 5T9050 2.5V single data rate (SDR) clock buffer is a single-ended input to five single-ended outputs buffer built on advanced metal CMOS technology. The SDR clock buffer fanout from a single input to five single-ended outputs reduces the loading on the preceding driver and provides an efficient clock distribution network. Multiple power and grounds reduce noise.

## FUNCTIONAL BLOCK DIAGRAM



## PIN CONFIGURATION



TSSOP  
TOP VIEW

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Symbol	Description	Max	Unit
V <sub>DD</sub>	Power Supply Voltage	-0.5 to +3.6	V
V <sub>I</sub>	Input Voltage	-0.5 to +3.6	V
V <sub>O</sub>	Output Voltage	-0.5 to V <sub>DD</sub> +0.5	V
T <sub>STG</sub>	Storage Temperature	-65 to +165	°C
T <sub>J</sub>	Junction Temperature	150	°C

### NOTE:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## CAPACITANCE<sup>(1)</sup> (T<sub>A</sub> = +25°C, F = 1.0MHz)

Symbol	Parameter	Min	Typ.	Max.	Unit
C <sub>IN</sub>	Input Capacitance	—	6	—	pF

### NOTE:

- This parameter is measured at characterization but not tested.

## RECOMMENDED OPERATING RANGE

Symbol	Description	Min.	Typ.	Max.	Unit
T <sub>A</sub>	Ambient Operating Temperature	-40	+25	+85	°C
V <sub>DD</sub>	Internal Power Supply Voltage	2.3	2.5	2.7	V

## PIN DESCRIPTION

Symbol	I/O	Type	Description
A	I	LVTTL	Clock input
G̅	I	LVTTL	Gate control for Q <sub>n</sub> outputs. When G̅ is LOW, these outputs are enabled. When G̅ is HIGH, these outputs are asynchronously disabled to the level designated by GL <sup>(1)</sup> .
GL	I	LVTTL	Specifies output disable level. If HIGH, the outputs disable HIGH. If LOW, the outputs disable LOW.
Q <sub>n</sub>	O	LVTTL	Clock outputs
V <sub>DD</sub>		PWR	Power supply for the device core, inputs, and outputs
GND		PWR	Power supply return for power

### NOTE:

- Because the gate controls are asynchronous, runt pulses are possible. It is the user's responsibility to either time the gate control signals to minimize the possibility of runt pulses or be able to tolerate them in down stream circuitry.

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE<sup>(1)</sup>

Symbol	Parameter	Test Conditions	Min.	Typ. <sup>(4)</sup>	Max	Unit
I <sub>IH</sub>	Input HIGH Current	V <sub>DD</sub> = 2.7V V <sub>I</sub> = V <sub>DD</sub> /GND	—	—	+5	μA
I <sub>IL</sub>	Input LOW Current	V <sub>DD</sub> = 2.7V V <sub>I</sub> = GND/V <sub>DD</sub>	—	—	+5	μA
V <sub>IK</sub>	Clamp Diode Voltage	V <sub>DD</sub> = 2.3V, I <sub>IN</sub> = -18mA	—	- 0.7	- 1.2	V
V <sub>IN</sub>	DC Input Voltage		- 0.3		+3.6	V
V <sub>IH</sub>	DC Input HIGH <sup>(2)</sup>		1.7		—	V
V <sub>IL</sub>	DC Input LOW <sup>(3)</sup>		—		0.7	V
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = -12mA	V <sub>DD</sub> - 0.4		—	V
		I <sub>OH</sub> = -100μA	V <sub>DD</sub> - 0.1		—	V
V <sub>OL</sub>	Output LOW Voltage	I <sub>OL</sub> = 12mA	—		0.4	V
		I <sub>OL</sub> = 100μA	—		0.1	V

### NOTES:

1. See RECOMMENDED OPERATING RANGE table.
2. Voltage required to maintain a logic HIGH.
3. Voltage required to maintain a logic LOW.
4. Typical values are at V<sub>DD</sub> = 2.5V, +25°C ambient.

## POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions <sup>(1)</sup>	Typ.	Max	Unit
I <sub>DDQ</sub>	Quiescent V <sub>DD</sub> Power Supply Current	V <sub>DD</sub> = Max., Reference Clock = LOW Outputs enabled. All outputs unloaded	1	1.5	mA
I <sub>DDD</sub>	Dynamic V <sub>DD</sub> Power Supply Current per Output	V <sub>DD</sub> = Max., C <sub>L</sub> = 0pF	100	150	μA/MHz
I <sub>TOT</sub>	Total Power V <sub>DD</sub> Supply Current	V <sub>DD</sub> = 2.5V., F <sub>REFERENCE CLOCK</sub> = 100MHz, C <sub>L</sub> = 15pF	50	65	mA
		V <sub>DD</sub> = 2.5V., F <sub>REFERENCE CLOCK</sub> = 200MHz, C <sub>L</sub> = 15pF	75	100	

### NOTE:

1. The termination resistors are excluded from these measurements.

## INPUT AC TEST CONDITIONS

Symbol	Parameter	Value	Units
V <sub>IH</sub>	Input HIGH Voltage	V <sub>DD</sub>	V
V <sub>IL</sub>	Input LOW Voltage	0	V
V <sub>TH</sub>	Input Timing Measurement Reference Level <sup>(1)</sup>	V <sub>DD</sub> /2	V
t <sub>R</sub> , t <sub>F</sub>	Input Signal Edge Rate <sup>(2)</sup>	2	V/ns

### NOTES:

1. A nominal 1.25V timing measurement reference level is specified to allow constant, repeatable results in an automatic test equipment (ATE) environment.
2. The input signal edge rate of 2V/ns or greater is to be maintained in the 10% to 90% range of the input waveform.

AC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE<sup>(4)</sup>

Symbol	Parameter	Min.	Typ.	Max	Unit
--------	-----------	------	------	-----	------

## Skew Parameters

$t_{sk(o)}$	Same Device Output Pin-to-Pin Skew <sup>(1)</sup>	—	—	25	ps
$t_{sk(p)}$	Pulse Skew <sup>(2)</sup>	—	—	300	ps
$t_{sk(pp)}$	Part-to-Part Skew <sup>(3)</sup>	—	—	300	ps

## Propagation Delay

$t_{PLH}$	Propagation Delay A to Qn	—	—	1.8	ns
$t_{PHL}$					
$t_R$	Output Rise Time (20% to 80%)	350	—	850	ps
$t_F$	Output Fall Time (20% to 80%)	350	—	850	ps
$f_o$	Frequency Range	—	—	200	MHz

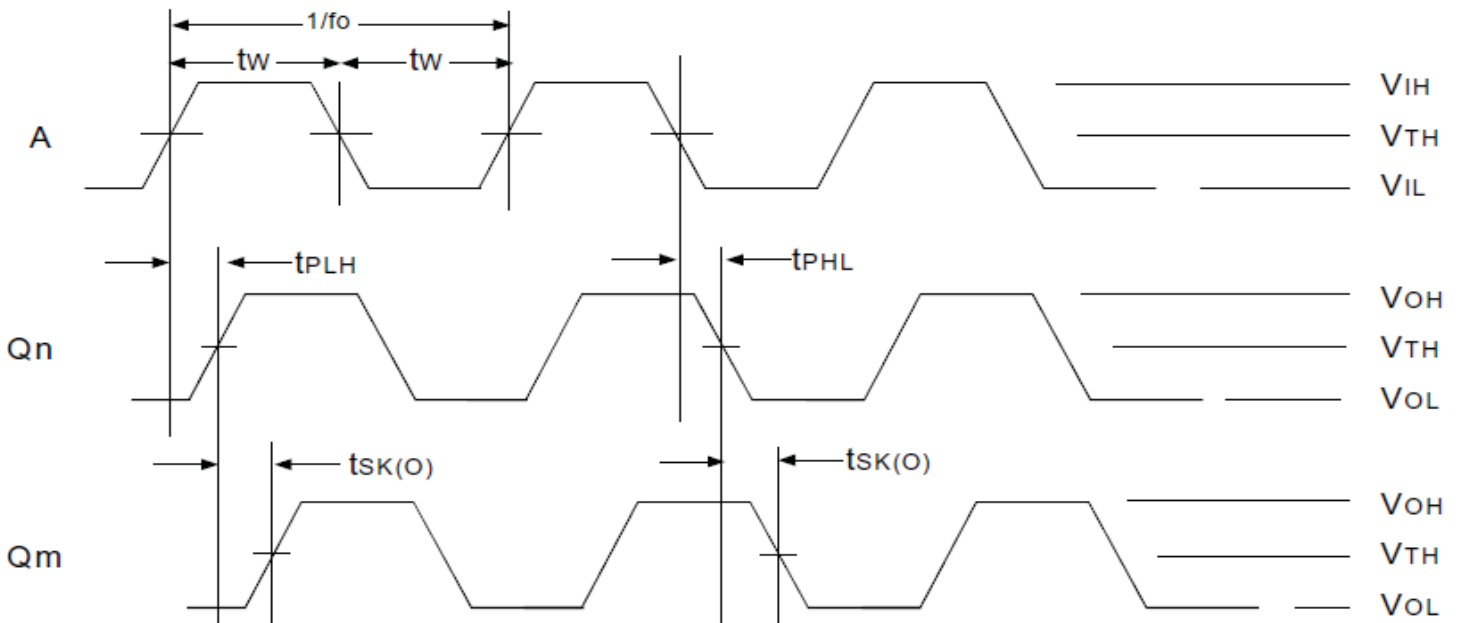
## Output Gate Enable/Disable Delay

$t_{PGE}$	Output Gate Enable to Qn	—	—	3.5	ns
$t_{PGD}$	Output Gate Enable to Qn Driven to GL Designated Level	—	—	3	ns

## NOTES:

1. Skew measured between all outputs under identical input and output transitions and load conditions on any one device.
2. Skew measured is the difference between propagation delay times  $t_{PHL}$  and  $t_{PLH}$  of any output under identical input and output transitions and load conditions on any one device.
3. Skew measured is the magnitude of the difference in propagation times between any outputs of two devices, given identical transitions and load conditions at identical  $V_{DD}$  levels and temperature.
4. Guaranteed by design.

## AC TIMING WAVEFORMS

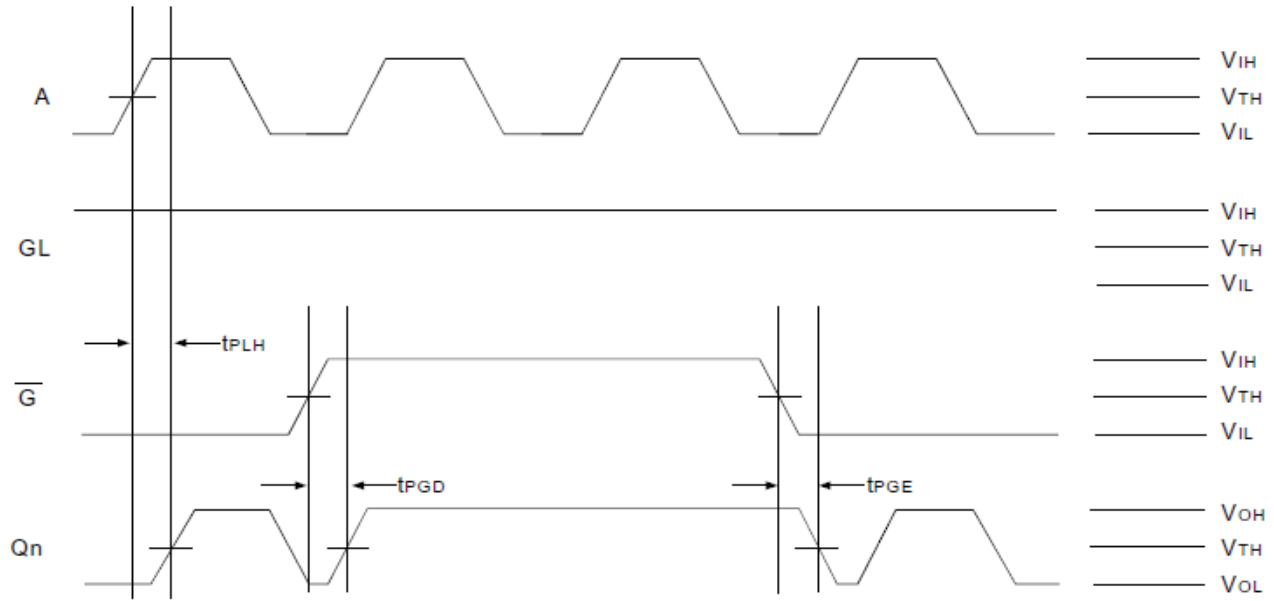


Propagation and Skew Waveforms

NOTE: Pulse Skew is calculated using the following expression:

$$t_{sk(p)} = |t_{PHL} - t_{PLH}|$$

where  $t_{PHL}$  and  $t_{PLH}$  are measured on the controlled edges of any one output from rising and falling edges of a single pulse. Please note that the  $t_{PHL}$  and  $t_{PLH}$  shown are not valid measurements for this calculation because they are not taken from the same pulse.

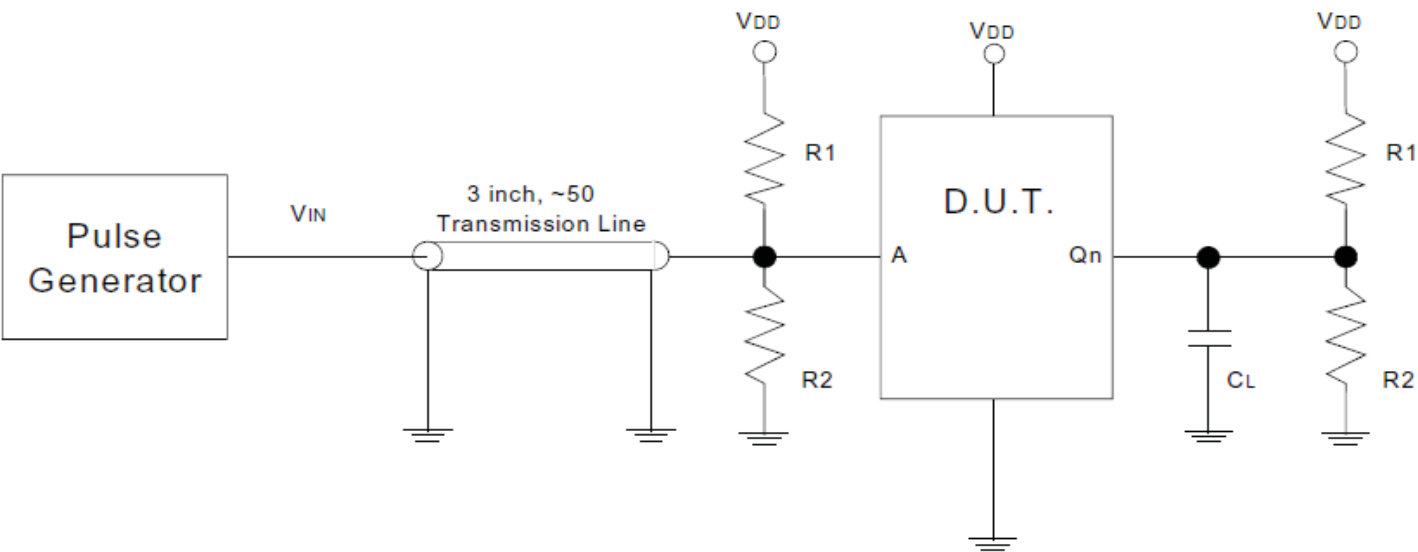


*Gate Disable/Enable Showing Runt Pulse Generation*

NOTE:

As shown, it is possible to generate runt pulses on gate disable and enable of the outputs. It is the user's responsibility to time their  $\overline{G}$  signal to avoid this problem.

TEST CIRCUIT AND CONDITIONS

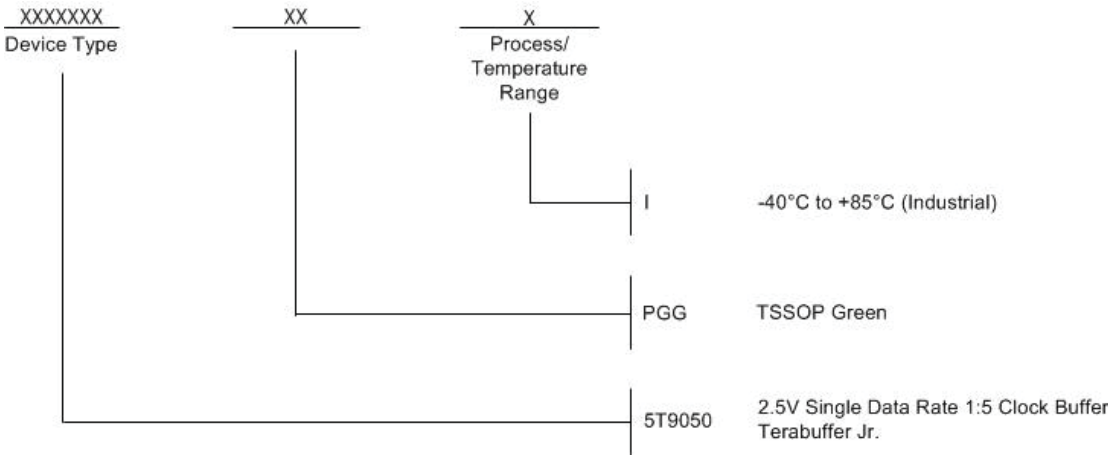


Test Circuit for Input/Output

INPUT/OUTPUT TEST CONDITIONS

Symbol	$V_{DD} = 2.5V \pm 0.2V$	Unit
$V_{TH}$	$V_{DD} / 2$	V
R1	100	$\Omega$
R2	100	$\Omega$
CL	15	pF

ORDERING INFORMATION



## REVISION HISTORY

Rev	Table	Page	Discription of Change	Date
A		1	NRND - Not Recommended for New Designs	5/5/13
A		1	Product Discontinuation Notice - Last time buy expires 11/2/2016. PDN# CQ-15-05	11/2/15



**Corporate Headquarters**

6024 Silver Creek Valley Road  
San Jose, California 95138

**Sales**

800-345-7015 or +408-284-8200  
Fax: 408-284-2775  
www.IDT.com

**Technical Support**

**email:** [clocks@idt.com](mailto:clocks@idt.com)

DISCLAIMER Integrated Device Technology, Inc. (IDT) and its subsidiaries reserve the right to modify the products and/or specifications described herein at any time and at IDT's sole discretion. All information in this document, including descriptions of product features and performance, is subject to change without notice. Performance specifications and the operating parameters of the described products are determined in the independent state and are not guaranteed to perform the same way when installed in customer products. The information contained herein is provided without representation or warranty of any kind, whether express or implied, including, but not limited to, the suitability of IDT's products for any particular purpose, an implied warranty of merchantability, or non-infringement of the intellectual property rights of others. This document is presented only as a guide and does not convey any license under intellectual property rights of IDT or any third parties.

IDT's products are not intended for use in applications involving extreme environmental conditions or in life support systems or similar devices where the failure or malfunction of an IDT product can be reasonably expected to significantly affect the health or safety of users. Anyone using an IDT product in such a manner does so at their own risk, absent an express, written agreement by IDT.

Integrated Device Technology, IDT and the IDT logo are registered trademarks of IDT. Other trademarks and service marks used herein, including protected names, logos and designs, are the property of IDT or their respective third party owners.

Copyright 2015. All rights reserved.